

PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material (6) | MSL Peak Temp (3) | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|-----------------|------|-------------|-----------------|--------------------------------------|----------------------|--------------|-------------------------|-------------------------|
| THVD1410D | ACTIVE | SOIC | D | 8 | 75 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | VD1410 | Samples |
| THVD1410DGK | ACTIVE | VSSOP | DGK | 8 | 80 | RoHS & Green | NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | 1410 | Samples |
| THVD1410DGKR | ACTIVE | VSSOP | DGK | 8 | 2500 | RoHS & Green | NIPDAU SN NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | 1410 | Samples |
| THVD1410DR | ACTIVE | SOIC | D | 8 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | VD1410 | Samples |
| THVD1450D | ACTIVE | SOIC | D | 8 | 75 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | VD1450 | Samples |
| THVD1450DGK | ACTIVE | VSSOP | DGK | 8 | 80 | RoHS & Green | NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | 1450 | Samples |
| THVD1450DGKR | ACTIVE | VSSOP | DGK | 8 | 2500 | RoHS & Green | NIPDAUAG SN | Level-1-260C-UNLIM | -40 to 125 | 1450 | Samples |
| THVD1450DR | ACTIVE | SOIC | D | 8 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | VD1450 | Samples |
| THVD1450DRBR | ACTIVE | SON | DRB | 8 | 3000 | RoHS & Green | SN | Level-1-260C-UNLIM | -40 to 125 | 1450 | Samples |
| THVD1450DRBT | ACTIVE | SON | DRB | 8 | 250 | RoHS & Green | SN | Level-1-260C-UNLIM | -40 to 125 | 1450 | Samples |
| THVD1451D | ACTIVE | SOIC | D | 8 | 75 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | VD1451 | Samples |
| THVD1451DR | ACTIVE | SOIC | D | 8 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | VD1451 | Samples |
| THVD1451DRBR | ACTIVE | SON | DRB | 8 | 3000 | RoHS & Green | SN | Level-1-260C-UNLIM | -40 to 125 | 1451 | Samples |
| THVD1451DRBT | ACTIVE | SON | DRB | 8 | 250 | RoHS & Green | SN | Level-1-260C-UNLIM | -40 to 125 | 1451 | Samples |
| THVD1452D | ACTIVE | SOIC | D | 14 | 50 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | 1452 | Samples |
| THVD1452DGS | ACTIVE | VSSOP | DGS | 10 | 80 | RoHS & Green | NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | 1452 | Samples |
| THVD1452DGSR | ACTIVE | VSSOP | DGS | 10 | 2500 | RoHS & Green | NIPDAUAG | Level-1-260C-UNLIM | -40 to 125 | 1452 | Samples |
| THVD1452DR | ACTIVE | SOIC | D | 14 | 2500 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | 1452 | Samples |

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ **RoHS:** TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (Cl) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of ≤ 1000 ppm threshold. Antimony trioxide based flame retardants must also meet the ≤ 1000 ppm threshold requirement.

⁽³⁾ **MSL, Peak Temp.** - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ **Lead finish/Ball material** - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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